July 2008

FDW2504P

IRCHI

SEMICONDUC

Dual P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

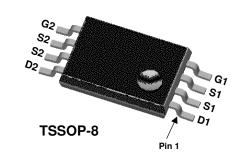
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

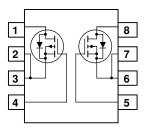
Applications

- · Load switch
- Motor drive
- DC/DC conversion
- Power management

Features

- -3.8 A, -20 V, $R_{DS(ON)} = 0.043 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(ON)} = 0.070 \ \Omega \ @ V_{GS} = -2.5 \ V$
- Extended V_{GSS} range (±12V) for battery applications
- Low gate charge
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Unite
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±12	V
I _D	Drain Current – Continuous	(Note 1)	-3.8	Α
	– Pulsed		-30	
PD	Power Dissipation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
T _J , T _{STG}	Operating and Storage Junction Temperatu	ire Range	55 to +150	°C
Therma	I Characteristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	125	°C/W
		(Note 1b)	208	

Device Marking	Device	Reel Size	Tape width	Quantity
2504P	FDW2504P	13"	12mm	2500 units

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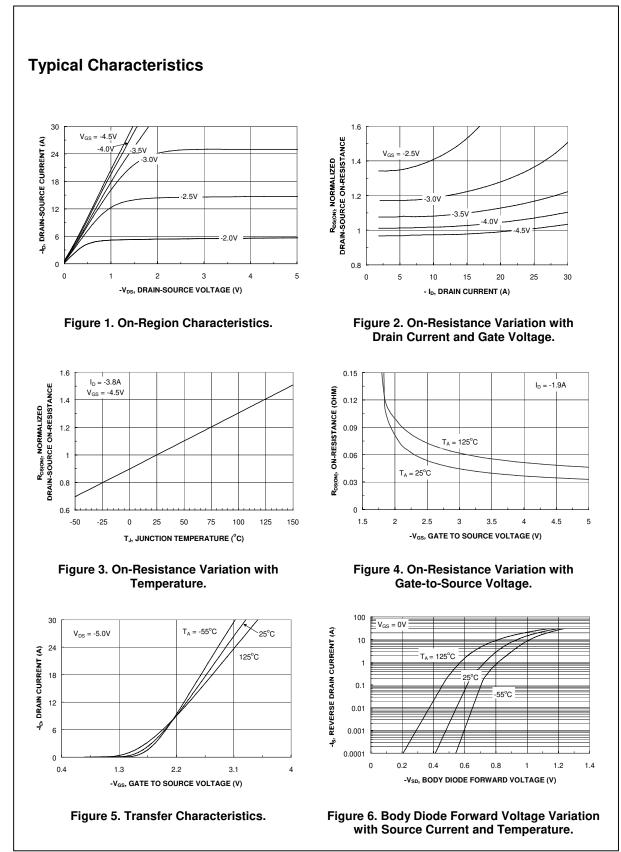
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	I				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-20			V
ΔBV_{DSS} $\Delta T_{,i}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-16		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -16 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = -12 \ V, \qquad V_{DS} = 0 \ V$			-100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{\text{GS}} = 12 \text{ V}, \qquad V_{\text{DS}} = 0 \text{ V}$			100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.6	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_{D} = –250 $\mu\text{A},$ Referenced to 25°C		3		mV/°(
R _{DS(on)}	Static Drain–Source On–Resistance	$\begin{array}{l} V_{GS}=-4.5 \ V, I_{D}=-3.8 \ A \\ V_{GS}=-2.5 \ V, I_{D}=-3.0 \ A \\ V_{GS}=-4.5 \ V, \ I_{D}=-3.8 \ A, \ T_{J}{=}125^{\circ}C \end{array}$		0.036 0.056 0.049	0.043 0.070 0.069	Ω
I _{D(on)}	On-State Drain Current		-15			Α
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -3.8 A$		13.2		S
Dynamic	Characteristics			•		
Ciss	Input Capacitance			1030		pF
C _{oss}	Output Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$, f = 1.0 MHz		280		pF
C _{rss}	Reverse Transfer Capacitance	T = 1.0 MHZ		120		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Turn–On Rise Time			18	32	ns
t _{d(off)}	Turn-Off Delay Time			34	55	ns
t _f	Turn-Off Fall Time			34	55	ns
Qg	Total Gate Charge	$ \begin{array}{l} V_{\text{DS}} = -5 \ \text{V}, & \ \text{I}_{\text{D}} = -3.8 \ \text{A}, \\ V_{\text{GS}} = -4.5 \ \text{V} \end{array} $		9.7	16	nC
Q _{gs}	Gate-Source Charge			2.2		nC
Q _{gd}	Gate-Drain Charge			2.4		nC
Drain-Se	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source	e Diode Forward Current			-0.83	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \ V, I_S = -0.83 \ A \ (Note 2)$		-0.7	-1.2	V

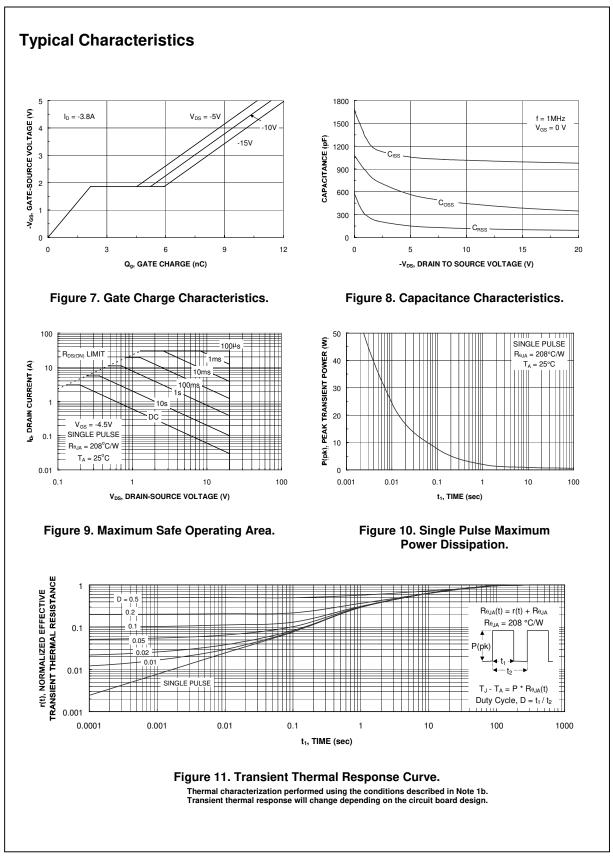
a) $\ \ R_{\theta,JA}$ is 125 °C/W (steady state) when mounted on 1 inch² copper pad on FR-4.

b) $~~R_{\theta JA}^{}$ is 208 °C/W (steady state) when mounted on minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0.



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FDW2504P Rev. E1 (W)



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